



RECOMMENDED PCB LAYOUT
PCB THICKNESS $t=1.6$

TABLE 1

PART NO.	A	B
△ LPC-4PM2 ()	2	5.2
△ LPC-18PM2 ()	16	19.2
LPC-20PM2 ()	18	21.2
△ LPC-26PM2 ()	24	27.2

△ TABLE 2

PART NO.	PLATING
LPC- (n) PM2	TIN/LEAD $2\mu\text{m}$
LPC- (n) PM2G	GOLD $0.2\mu\text{m}$

NOTE1. "n" SHOWS NUMBER OF CONTACTS.

2. AS FOR THE DIMENTION, SEE TABLE #1.

△									
△	APR.05.2005	T. O	ADD P/N AND PLATING	2	CONTACT	PHOSPHOR BRONZE	n	SEE TABLE #2	—
△	FEB.19.1999	K. K	26 POS. ADD	1	INSULATOR	PA66	1	—	UL94V-0 BLACK
LTR.	DATE	BY	REV. DESCRIPT	No.	PART NAME	MATERIAL	QTY	FINISH	NOTE
DATE		SCALE		UNIT		3RD. A. P			
JAN.25 (1999)		5/1		mm (INCH)		HTK HONDA TSUSHIN KOGYO CO., LTD.			
APP. DATE&REV.					NAME		MALE CONNECTOR		
DR.	DE.	CHK.	CHK.	APP.	PART NO.		LPC- () PM2 () △		REV.
T. ODA	T. ODA	—	C. NUNOKAWA	H. EBIHARA					2B